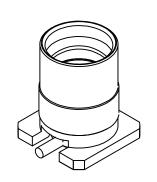
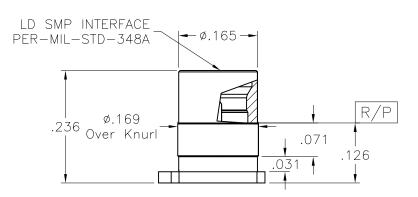
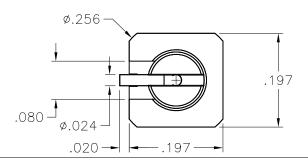
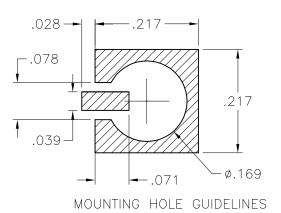
COMPONENT	MATERIAL	FINISH
CONTACT & SMT BODY	BeCu TEMPER TD04 ALLOY C17300, ASTM B196	GOLD PLATE PER ASTM B-488 50 MICROINCHES MIN. OVER NICKEL PLATE PER QQ-N-290, 50 MICROINCHES MIN
INSULATOR	TORLON (POLYAMIDE-IMIDE) ASTM D5204	_









THESE DIMENSIONS ARE GUIDELINES FOR OPTIMUM SOLDERABILITY.
THESE DIMENSIONS
MAY VARY DEPENDING
FREQUENCY, MATERIALS
AND PROCESSES USED.

NOTE:

ALL DIMENSIONS NOMINAL UNLESS OTHERWISE SPECIFIED

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INSERTION/EXTRACTION TOOL	TITLE		
N/A	SMP LD PIN P.C.B. S	URFACE MOUNT R/A LAUNCH	
MOUNTING PROCEDURE	CATALOG NUMBER	DRAWING NUMBER	REV.
N/A	<i>100-123-1668</i>	508A11054	А